MBR4020
MBR4030
MBR4040

MOTOROLA

3

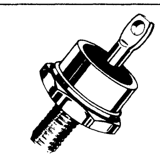
HOT CARRIER POWER RECTIFIER

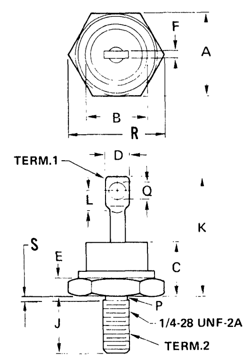
. . . employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v_F
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity

SCHOTTKY BARRIER RECTIFIERS

40 AMPERE
20,30,40 VOLTS





DIM	MILLIMETERS MIN	MILLIMETERS MAX	INCHES MIN	INCHES MAX
A	16.94	17.45	0.669	0.687
B	–	16.94	–	0.667
C	–	11.43	–	0.450
D	–	9.53	–	0.375
E	2.92	5.08	0.115	0.200
F	–	2.03	–	0.080
J	10.72	11.51	0.422	0.453
K	–	25.40	–	1.000
L	3.86	–	0.156	–
P	5.59	6.32	0.220	0.249
Q	3.56	4.45	0.140	0.175
R	–	20.16	–	0.794
S	–	2.26	–	0.089

NOTES:
1. DIM "P" IS DIA.
2. CHAMFER OR UNDERCUT ON ONE OR BOTH ENDS OF HEXAGONAL BASE IS OPTIONAL.
3. ANGULAR ORIENTATION AND CONTOUR OF TERMINAL ONE IS OPTIONAL.
4. THREADS ARE PLATED.
5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

CASE 257-01
DO-5

MAXIMUM RATINGS

Rating	Symbol	MBR4020	MBR4030	MBR4040	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	V_{RSM}	24	36	48	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2\ V_{R(dc)}$, $T_C = 70^oC$	I_O	← 40 →			Amp
Ambient Temperature Rated $V_{R(dc)}$, $P_{F(AV)} = 0$, $R_{\theta JA} = 2.0^oC/W$	T_A	100	95	90	^oC
Non-Repetitive Peak Surge Current (surge applied at rated load conditions halfwave, single phase, 60 Hz)	I_{FSM}	← 800 (for 1 cycle) →			Amp
Operating and Storage Junction Temperature Range (Reverse voltage applied)	T_J, T_{stg}	← -65 to +125 →			^oC
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	← 150 →			^oC

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	$^oC/W$

ELECTRICAL CHARACTERISTICS ($T_C = 25^oC$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Maximum Instantaneous Forward Voltage (1) ($i_F = 40$ Amp)	v_F	–	–	0.630	Volts
Maximum Instantaneous Reverse Current @ rated dc Voltage (1) $T_C = 100^oC$	i_R	– –	– –	20 150	mA

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2.0%.

NOTE 1: DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.2 V_{RWM}. Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_{J(max)} - R_{\theta JA}\,P_{F(AV)} - R_{\theta JA}\,P_{R(AV)} \quad (1)$$

where

$T_{A(max)}$ = Maximum allowable ambient temperature

$T_{J(max)}$ = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).

$P_{F(AV)}$ = Average forward power dissipation

$P_{R(AV)}$ = Average reverse power dissipation

$R_{\theta JC}$ = Junction-to-ambient thermal resistance

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_{J(max)} - R_{\theta JA}\,P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA}\,P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that T_R is the ambient temperature at which thermal runaway occurs or where T_J = 125°C, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and 3 as a difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2 and 3 is based upon dc conditions. For use in common rectifier circuits, Table I indicates suggested factors for an equivalent dc voltage to use for conservative design; i.e.:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find $T_{A(max)}$ for MBR4040 operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that I_{DC} = 30 A ($I_{F(AV)}$ = 15 A), $I_{(PK)}/I_{(AV)}$ = 10, Input Voltage = 10 V(rms), $R_{\theta JA}$ = 3°C/W.

Step 1: Find $V_{R(equiv)}$. Read F = 0.65 from Table I ∴ $V_{R(equiv)}$ = (10)(1.41)(0.65) = 9.18 V

Step 2: Find T_R from Figure 3. Read T_R = 118°C @ V_R = 9.18 V & $R_{\theta JA}$ = 3°C/W

Step 3: Find $P_{F(AV)}$ from Figure 4. Read $P_{F(AV)}$ = 25 W @ $\frac{I_{(PK)}}{I_{(AV)}}$ = 10 & $I_{F(AV)}$ = 15 A

Step 4: Find $T_{A(max)}$ from equation (3). $T_{A(max)}$ = 118-(3)(25) = 43°C.

3

TABLE I — VALUES FOR FACTOR F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped (1),(2)	
Load	Resistive	Capacitive (1)	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

(1) Note that $V_{R(PK)} \approx 2\,V_{in(PK)}$

(2) Use line to center tap voltage for V_{in}.

FIGURE 1 — MAXIMUM REFERENCE TEMPERATURE — MBR4020

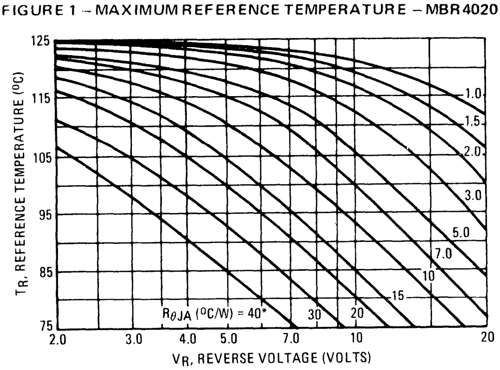


FIGURE 2 — MAXIMUM REFERENCE TEMPERATURE — MBR4030

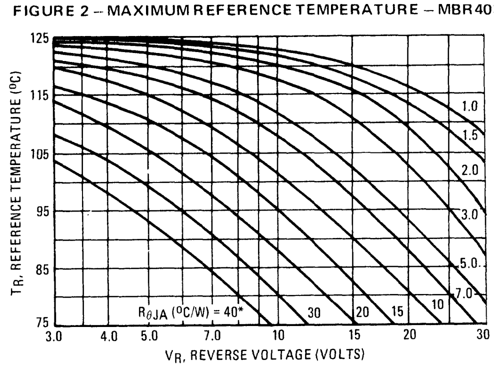
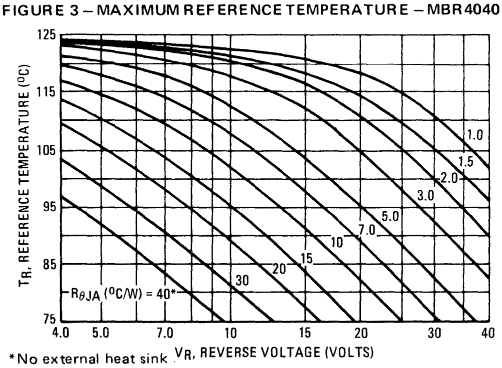


FIGURE 3 — MAXIMUM REFERENCE TEMPERATURE — MBR4040



*No external heat sink

FIGURE 4 — FORWARD POWER DISSIPATION

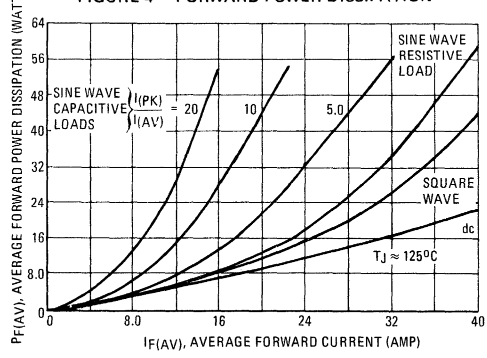


FIGURE 5 — TYPICAL FORWARD VOLTAGE

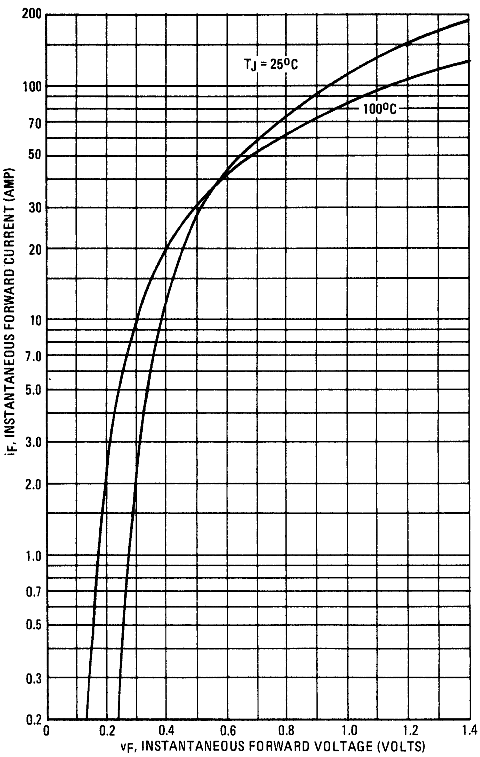


FIGURE 6 — MAXIMUM SURGE CAPABILITY

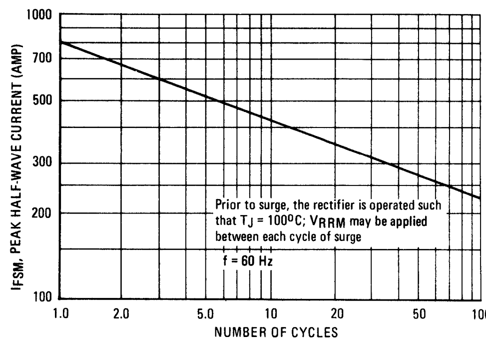


FIGURE 7 — CURRENT DERATING

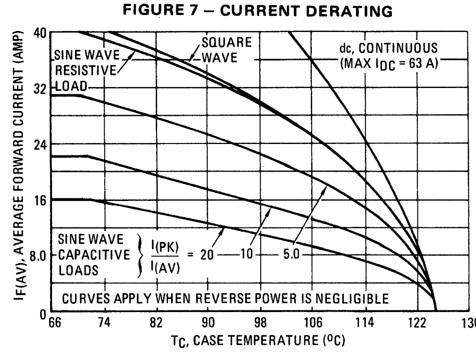


FIGURE 8 — THERMAL RESPONSE

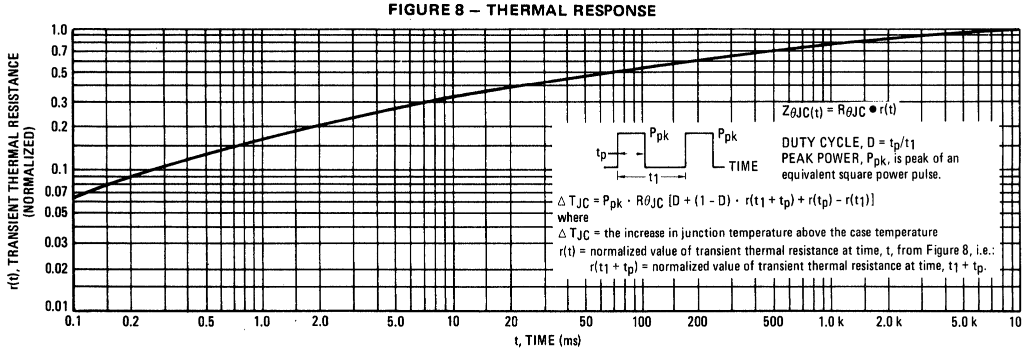


FIGURE 9 – NORMALIZED REVERSE CURRENT

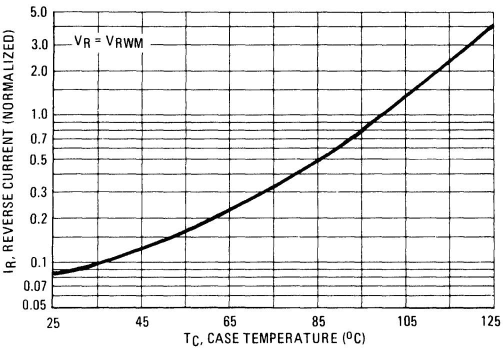


FIGURE 10 – TYPICAL REVERSE CURRENT

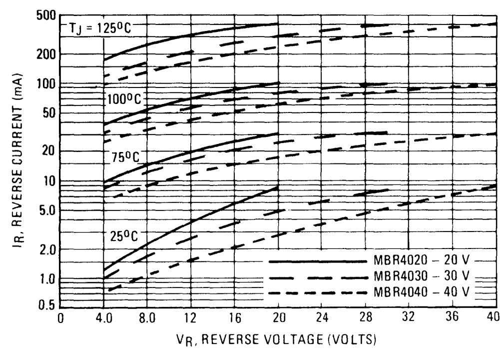
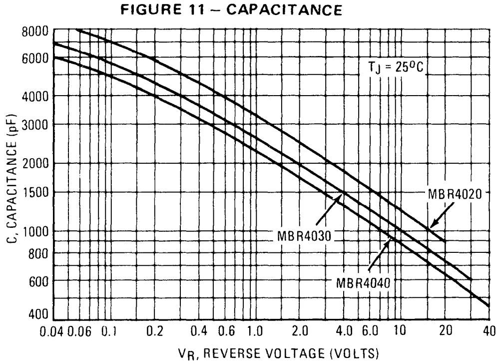


FIGURE 11 – CAPACITANCE



NOTE 2: HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11).

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

MECHANICAL CHARACTERISTICS

CASE: Welded, hermetically sealed

FINISH: All external surfaces corrosion resistant and terminal lead is readily solderable.

POLARITY: Cathode to Case

MOUNTING POSITION: Any

STUD TORQUE: 25 in. lb. Max

NOTE 3: SOLDER HEAT

The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.

3